

## N-Channel Enhancement Mode Field Effect Transistor

## General Description

The CMSA150N03L uses advanced technology to provide excellent RDS (ON) . This device is suitable to be used as the low side FET in SMPS,load switching and general purpose.

## Features

- Fast switching speed
- Lower On-resistance
- 100% EAS Guaranteed
- Simple Drive Requirement

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D@T_C=25^\circ\text{C}$	Continuous Drain Current	120	A
$I_D@T_C=100^\circ\text{C}$	Continuous Drain Current	96	A
$I_{DM}$	Pulsed Drain Current	360	A
EAS	Single Pulse Avalanche Energy <sup>1</sup>	260	mJ
$P_D@T_C=25^\circ\text{C}$	Total Power Dissipation	50	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

## Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Junction-to-Ambient	---	50	$^\circ\text{C/W}$
$R_{\theta JC}$	Junction-to-Case	---	1.6	$^\circ\text{C/W}$

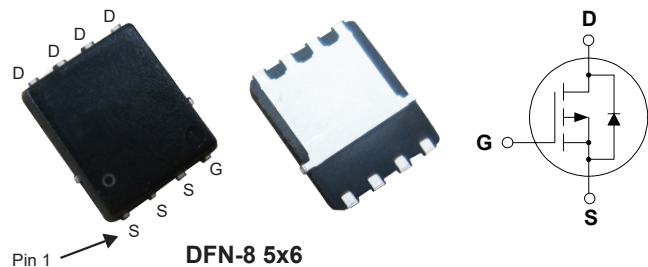
## Product Summary

BVDSS	RDSON	ID
30V	3.3m $\Omega$	120A

## Applications

- Load Switch
- Power Management in Notebook Computer, Portable Equipment and Battery Powered Systems.

## DFN-8 5x6 Pin Configuration



Type	Package	Marking
CMSA150N03L	DFN-8 5*6	CMSA150N03L

## N-Channel Enhancement Mode Field Effect Transistor

Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V$ , $I_D=250\mu A$	30	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$ , $I_D=20A$	---	---	3.3	m $\Omega$
		$V_{GS}=4.5V$ , $I_D=15A$	---	---	7.5	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250\mu A$	1	---	3	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=30V$ , $V_{GS}=0V$ , $T_J=25^{\circ}\text{C}$	---	---	1	$\mu A$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$	---	---	$\pm 100$	nA
$g_{fs}$	Forward Transconductance	$V_{DS}=5V$ , $I_D=15A$	---	23	---	S
$R_g$	Gate Resistance	$V_{DS}=0V$ , $V_{GS}=0V$ , $f=1\text{MHz}$	---	2.5	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{DD}=15V$ , $I_D=23A$ $V_{GS}=10V$	---	40	---	nC
$Q_{gs}$	Gate-Source Charge		---	8	---	
$Q_{gd}$	Gate-Drain Charge		---	5	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=15V$ , $R_G=6\Omega$ $I_D=23A$ , $V_{GEN}=10V$	---	15	---	ns
$T_r$	Rise Time		---	6	---	
$T_{d(off)}$	Turn-Off Delay Time		---	33	---	
$T_f$	Fall Time		---	5	---	
$C_{iss}$	Input Capacitance	$V_{DS}=15V$ , $V_{GS}=0V$ , $f=1\text{MHz}$	---	2800	---	pF
$C_{oss}$	Output Capacitance		---	1500	---	
$C_{rss}$	Reverse Transfer Capacitance		---	340	---	

## Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V$ , Force Current	---	---	120	A
$I_{SM}$	Pulsed Source Current		---	---	360	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V$ , $I_F=15A$	---	---	1.2	V

Note :

1.The test condition is  $V_{DD}=25V$  ,  $V_{GS}=10V$  ,  $L=0.5\text{mH}$  ,  $I_{AS}=32.5A$ 

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